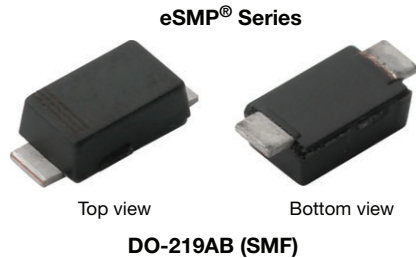


Surface Mount Schottky Barrier Rectifier



FEATURES

- Low profile package
- Ideal for automated placement
- Low forward voltage drop, low power losses
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

 AUTOMOTIVE
GRADE
Available

RoHS
COMPLIANT
HALOGEN
FREE

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: DO-219AB (SMF)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

| PRIMARY CHARACTERISTICS | |
|--|----------------|
| $I_{F(AV)}$ | 1.0 A |
| V_{RRM} | 100 V |
| I_{FSM} | 40 A |
| V_F at $I_F = 1.0$ A ($T_A = 125$ °C) | 0.57 V |
| T_J max. | 175 °C |
| Package | DO-219AB (SMF) |
| Diode variations | Single die |

| MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted) | | | |
|---|----------------------------|-------------|------|
| PARAMETER | SYMBOL | SS1FH10 | UNIT |
| Device marking code | | 110 | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 100 | V |
| Maximum average forward rectified current (fig. 1) | $I_{F(AV)}$ ⁽¹⁾ | 1.0 | A |
| Non-repetitive peak forward surge current 8.3 ms single half sine-wave at $T_{J(init)} = 25$ °C | I_{FSM} | 40 | A |
| Operating junction and storage temperature range | T_J, T_{STG} | -55 to +175 | °C |

Note

⁽¹⁾ Free air, mounted on recommended copper pad area



| ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | | | | |
|---|----------------------|-----------------------------------|-------------|------|------|---------------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Instantaneous forward voltage | $I_F = 0.5\text{ A}$ | $T_A = 25\text{ }^\circ\text{C}$ | $V_F^{(1)}$ | 0.65 | - | V |
| | $I_F = 1.0\text{ A}$ | | | 0.72 | 0.80 | |
| | $I_F = 0.5\text{ A}$ | $T_A = 125\text{ }^\circ\text{C}$ | | 0.51 | - | |
| | $I_F = 1.0\text{ A}$ | | | 0.57 | 0.65 | |
| Reverse current | $V_R = 100\text{ V}$ | $T_A = 25\text{ }^\circ\text{C}$ | $I_R^{(2)}$ | - | 5 | μA |
| | | $T_A = 125\text{ }^\circ\text{C}$ | | 65 | 160 | |
| Typical junction capacitance | 4.0 V, 1 MHz | | C_J | 70 | - | pF |

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
(2) Pulse test: Pulse width $\leq 5\text{ ms}$

| THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | |
|--|-----------------------------|---------|--------------------|
| PARAMETER | SYMBOL | SS1FH10 | UNIT |
| Typical thermal resistance | $R_{\theta JA}^{(1)(2)(3)}$ | 125 | $^\circ\text{C/W}$ |
| | $R_{\theta JM}^{(2)(3)}$ | 26 | |

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
(2) Device mounted on FR4 PCB, 2 oz. standard footprint
(3) Thermal resistance $R_{\theta JA}$ - junction to ambient; $R_{\theta JM}$ - junction to mount

| ORDERING INFORMATION (Example) | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| SS1FH10-M3/H | 0.015 | H | 3000 | 7" diameter plastic tape and reel |
| SS1FH10-M3/I | 0.015 | I | 10 000 | 13" diameter plastic tape and reel |
| SS1FH10HM3/H ⁽¹⁾ | 0.015 | H | 3000 | 7" diameter plastic tape and reel |
| SS1FH10HM3/I ⁽¹⁾ | 0.015 | I | 10 000 | 13" diameter plastic tape and reel |

Note

- (1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

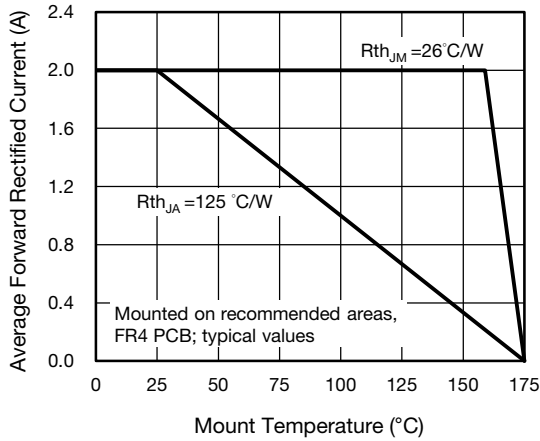


Fig. 1 - Typical Forward Current Derating Curve

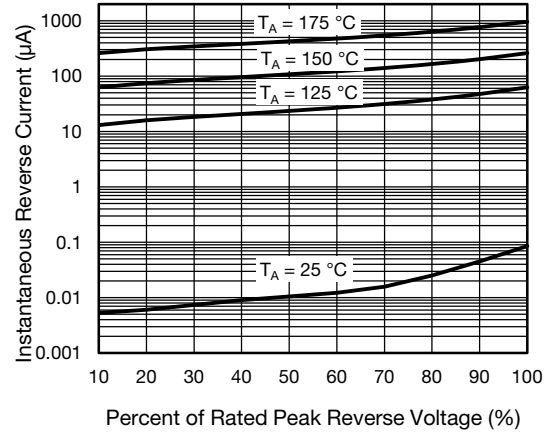


Fig. 4 - Typical Reverse Leakage Characteristics

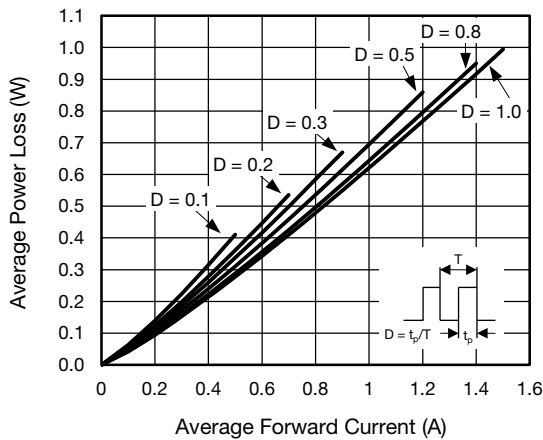


Fig. 2 - Forward Power Loss Characteristics

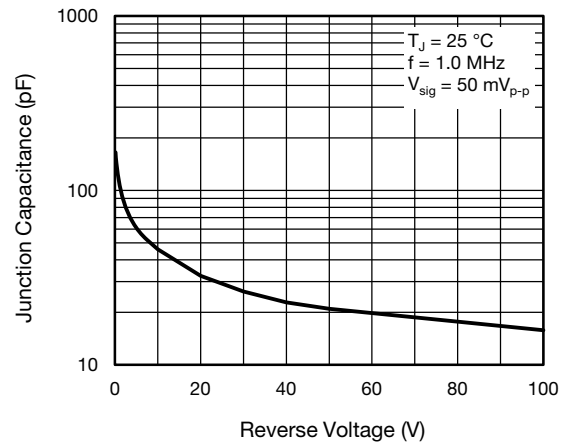


Fig. 5 - Typical Junction Capacitance

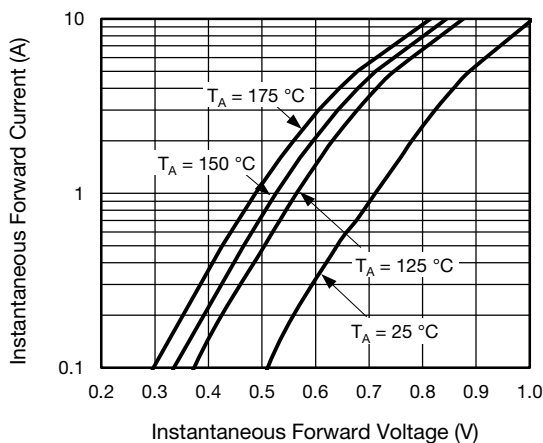


Fig. 3 - Typical Instantaneous Forward Characteristics

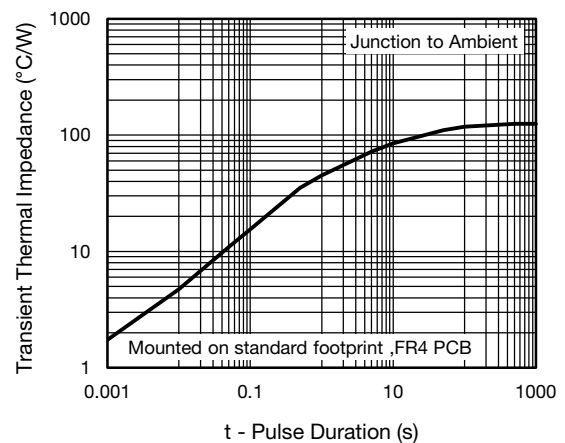
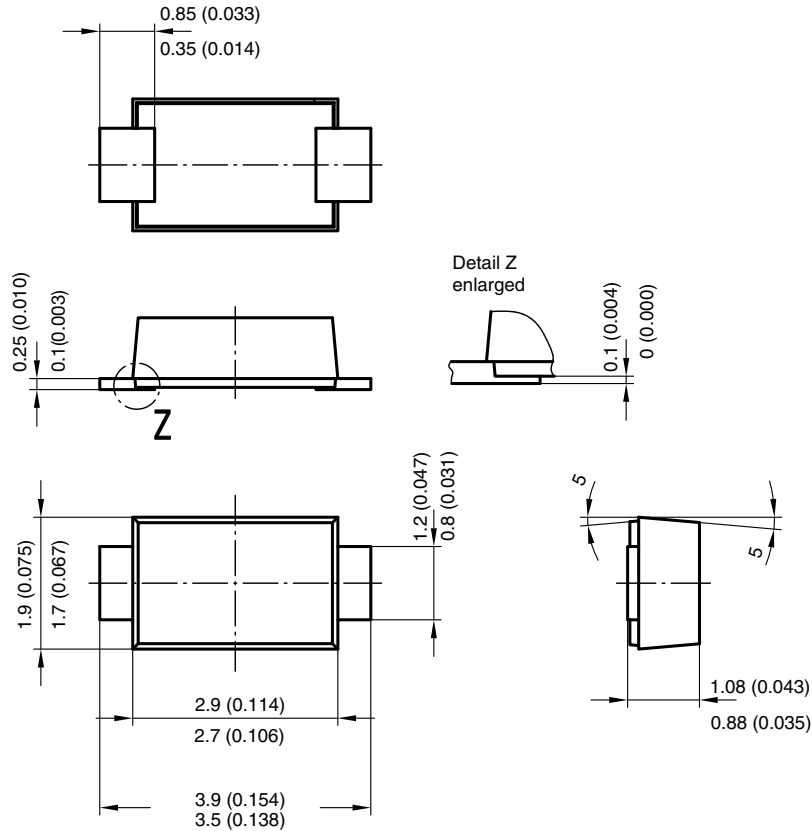


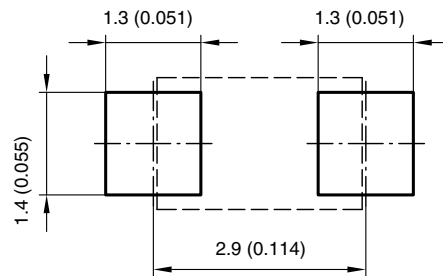
Fig. 6 - Typical Transient Thermal Impedance



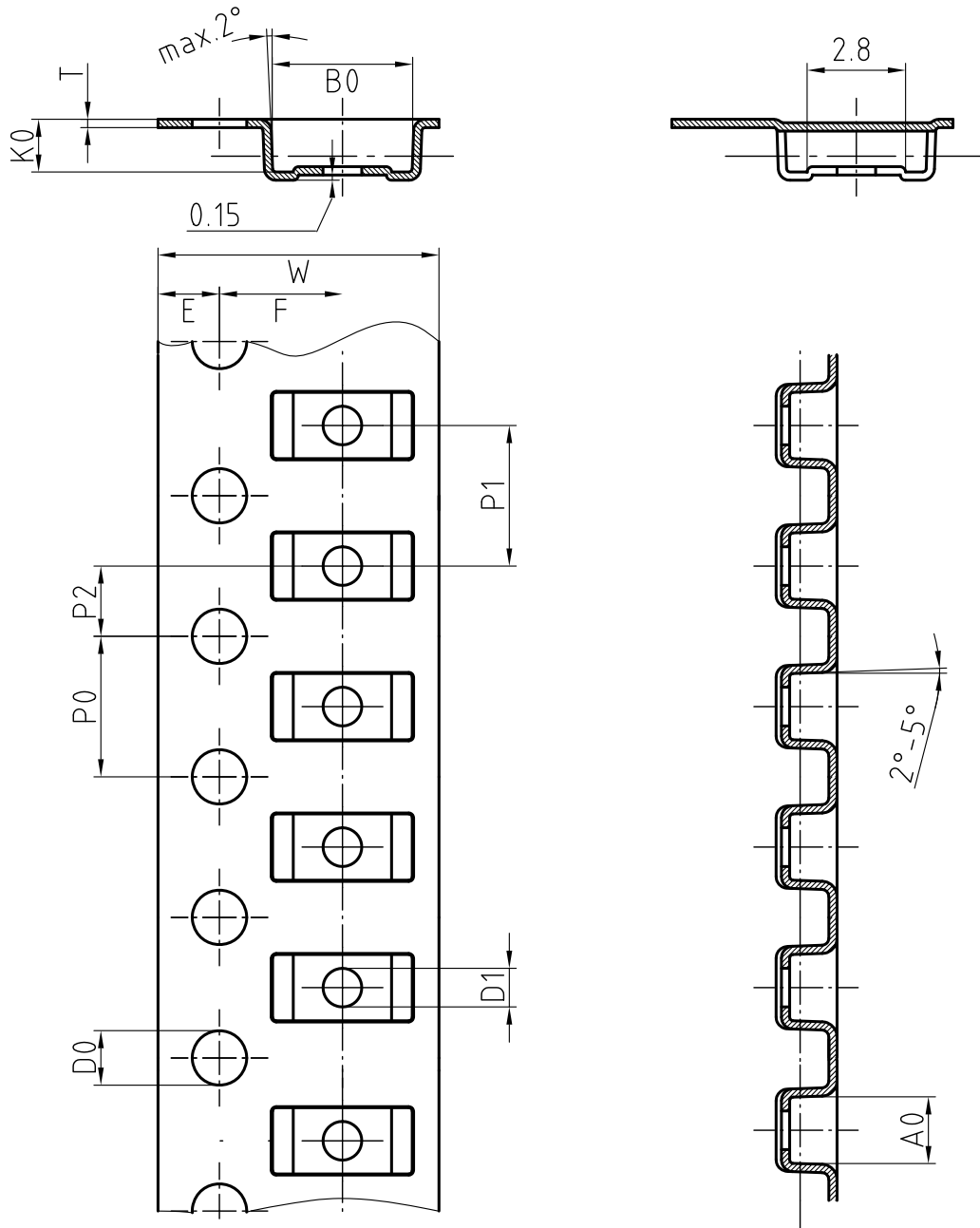
PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



Created - Date: 15. February 2005
 Rev. 3 - Date: 13. March 2007
 Document no.: S8-V-3915.01-001 (4)
 17247

BLISTERTAPE DIMENSIONS in millimeters: **DO-219AB (SMF)**


| Mat: | A0 | B0 | K0 | W | T | P0 | P2 | P1 | D0 | D1 | E | F |
|------|-----|-----|-----|-----|-------|-----|-----|-----|-----|----|------|-----|
| PS | 1.9 | 4.0 | 1.5 | 8.0 | 0.235 | 4.0 | 2.0 | 4.0 | 1.5 | 1 | 1.75 | 3.5 |

Document-No.: S8-V-3717.02-001 (3)

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